



Customer No.: 31561
Application No.: 10/707,609
Docket No.: 10073-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: Trinh, Hoa B

Group Art Unit: 2814

In re PATENT APPLICATION of

Applicants : Yu-Wen Chen)
Serial No. : 10/707,609)
Filed : December 24, 2003) AMENDMENT
For : Flip Chip Package Structure)
) Attorney Docket: 10073-US-PA
)

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10073-US-PA)

AMENDMENT AND RESPONSE TO OFFICE ACTION

U.S. Patent and Trademark Office
Commissioner for Patents
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Dear Sir:

The Office Action dated December 09, 2004, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.